

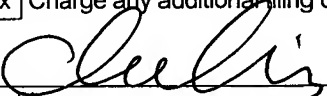


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Express Mail No. EV853144326US

Attorney Docket No. 108298705US  
Disclosure No. 02-1067.00/US

AMENDMENT TRANSMITTAL LETTER				Docket No. 108298705US	
Application No. 10/665,219-Conf. #6284		Filing Date September 17, 2003		Examiner D. V. Nguyen	
				Art Unit 3723	
Applicant(s): Lee et al.					
Invention: METHODS AND APPARATUS FOR REMOVING CONDUCTIVE MATERIAL FROM A MICROELECTRONIC SUBSTRATE					
<b>TO THE COMMISSIONER FOR PATENTS</b>					
Transmitted herewith is an amendment in the above-identified application.					
The fee has been calculated and is transmitted as shown below.					
<b>CLAIMS AS AMENDED</b>					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	56	- 71 =		x	
Independent Claims	18	- 18 =		x	
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:</b>					0.00
<input checked="" type="checkbox"/> Large Entity <input type="checkbox"/> Small Entity					
<input checked="" type="checkbox"/> No additional fee is required for this amendment.					
<input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of \$ _____. A duplicate copy of this sheet is enclosed.					
<input type="checkbox"/> A check in the amount of \$ _____ to cover the filing fee is enclosed.					
<input type="checkbox"/> Payment by credit card. Form PTO-2038 is attached.					
<input checked="" type="checkbox"/> The Director is hereby authorized to charge and credit Deposit Account No. <u>50-0665</u> as described below. A duplicate copy of this sheet is enclosed.					
<input checked="" type="checkbox"/> Credit any overpayment.					
<input checked="" type="checkbox"/> Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.					
 Chen Liang Attorney/Agent Reg. No.: 51,945				Dated: <u>May 19, 2006</u>	
PERKINS COIE LLP P.O. Box 1247 Seattle, Washington 98111-1247 (206) 359-8000					



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: WHONCHEE LEE ET AL.  
APPLICATION No.: 10/665,219  
FILED: SEPTEMBER 17, 2003  
FOR: **METHODS AND APPARATUS FOR  
REMOVING CONDUCTIVE MATERIAL  
FROM A MICROELECTRONIC  
SUBSTRATE**

EXAMINER: DUNG V. NGUYEN  
ART UNIT: 3723  
CONF. No: 6284

**Response Under 37 C.F.R. § 1.111**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated February 21, 2006 in the above-identified application. Please consider the application in light of the following remarks.

The pending claims are presented in the listing of claims beginning on page 2.